



Cite this: *RSC Adv.*, 2018, 8, 10355

# Thermal debinding mass transfer mechanism and dynamics of copper green parts fabricated by an innovative 3D printing method

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To explore the thermal debinding mass transfer mechanism and dynamics of an innovative copper paste injection 3D printing method, the thermal behavior of the copper paste was investigated to clarify the stages of the debinding process. Furthermore, the debinding ratio, burnout ratio, shrinkage and microstructures were characterized to study the mass transfer channel and dynamics. The dynamics equation of diffusion mass transfer was analyzed. The activation energy and pre-exponential factor were calculated. The results revealed that gas phase mass transfer was the main mass transfer path and the diffusion coefficient in the carbon powder embedded environment ( $2.68 \times 10^{-5} \text{ cm}^2 \text{ s}^{-1}$ ) was higher than that in air atmosphere ( $1.96 \times 10^{-5} \text{ cm}^2 \text{ s}^{-1}$ ). Moreover, the migration of solid phase materials and the diffusion of atoms are also discussed. When combined with the sintering process, the sintered metal parts had a smooth surface flatness and excellent metallurgical bonding, the thin wall of which was only 340  $\mu\text{m}$  thick.

Received 8th December 2017

Accepted 14th February 2018

DOI: 10.1039/c7ra13149f

rsc.li/rsc-advances

## 1 Introduction

Metal 3D printing technologies such as laser micro sintering (LMS), selective laser melting (SLM) and electron beam melting (EBM) are capable of manufacturing metal components with complex structures and advanced functionalities<sup>1,2</sup> and have been widely applied in aviation, medical and other high-end fields.<sup>3–5</sup> However, the extremely fast conditions during the laser or electron beam melt-forming process often makes it easy to form crack defects, severely affecting the mechanical properties. A recent study reported that the use of a nano zirconium-based nucleating agent to assemble alloy powder can effectively inhibit micro-cracks and improve the strength of the alloy.<sup>6</sup> However, this very innovative tool still cannot completely solve the problems of the limited range of printable materials and extremely expensive equipment that have existed for a long time.<sup>7</sup>

To avoid these problems, a low-cost 3D printing technique *via* metal paste injection 3D printing was developed. It involves the use of the material deposition principle for forming a 3D shape layer-by-layer, similar to the fused deposition modeling

(FDM).<sup>8,9</sup> However, it requires a debinding and sintering process to remove the adhesive material and consolidate the metallic materials. A specific binder wax material is mixed with fine metal particles to formulate paste composite, which is then heated to form a semi-melt paste and injected from the fine deposition nozzle; then, the injected material is cooled and solidified layer-by-layer to form 3D shapes. Then, the green part is heated in an oven to vaporize the binder during the debinding stage and the remaining powder is sintered into a dense part, similar to the process of metal injection molding (MIM).<sup>10,11</sup> As the use of a mold is not required, our method shows a clear advantage over MIM in terms of complex metallic structure fabrication. In this study, the main research purpose was to explore the mass transfer mechanism and dynamics during the debinding process.

As a new and emerging technology, it requires further research regarding basic scientific problems. The related studies reported that a 3D printer with an extrusion device could be used to deposit copper powder and polymer paste with high viscosity to form metal parts.<sup>12–14</sup> Thus, the feasibility of our method has been initially confirmed, but there was no systematic discussion of the forming process and mechanism, particularly the essential debinding process such as MIM. Therefore, to guide the production of metal components with high performance, the basic scientific problems of debinding and the sintering mechanism should be clarified. In this study, the debinding process is extremely important for forming 3D metal structures. If the debinding process parameters such as the excessive heating rate and the short holding time are not

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properly controlled, it would cause cracks or bubbling of metal components and even make it impossible to remove the complex metal 3D structure. Because the diffusion of metal atoms does not occur on a large scale in the debinding stage, the bonding between particles is physical and thus, the mechanical properties are not strong. Therefore, revealing the law of changes in physical and chemical properties of the green part is helpful in controlling the debinding process, which plays a crucial role in the manufacture of metal and alloy components. It is not hard to understand that during the debinding process, a series of basic physical changes and chemical reactions occurs, such as melting and vaporization of adhesives, decomposition of adhesives, migration and diffusion of adhesives under different physical states as well as the diffusion of adhesive decomposition products. To explore these basic scientific issues, the mass transfer mechanism and dynamics during the debinding process were mainly investigated quantitatively in this study.

For a discussion of the debinding problems, there are literature reports that can be referred to,<sup>15–17</sup> most of which were published in the field of MIM (mentioned above). However, most studies focused on the relationship between debinding process parameters and the properties of sintered parts and rarely involved analysis of the mass transfer mechanism and dynamic problems. Nevertheless, the process of debinding kinetics is the fundamental basis for determining the heating system in the MIM debinding process.<sup>18</sup> The existing basic theories regarding the dynamics of the debinding of MIM mainly include Young's equation<sup>19</sup>, Fick's law<sup>20</sup> and Vetter's equation<sup>21</sup>, providing the theoretical foundation for this study. Unlike MIM technology, however, metal paste injection 3D printing technology does not use molds and is not stressed, so unlike MIM, whether the surface interface conditions of the material systems in this study and smaller and more complex dimensions of the green part shape will bring interesting results remains to be explored. Nevertheless, we insist that the basic theory of debinding dynamics mentioned above in MIM can be used to explain debinding in metal paste injection 3D printing and it has some innovation in research of the topic, which has not been reported in the related field of 3D printing till date.

In this study, paraffin wax was selected as the binder to prepare the copper paste. The debinding experiment was carried out with embedded carbon powder. The mass transfer mechanism and dynamics problems were analyzed and discussed as key topics. In addition, the migration of solid phase materials and the diffusion of metal atoms were considered creatively.

## 2 Experiment

Copper powder with average size of 1  $\mu\text{m}$  (purity >99.5%) and paraffin wax ( $0.9\text{ g cm}^{-3}$ ) were mixed to prepare copper paste according to the mass ratio of powder to paraffin ( $m_1 : m_2$ ) of 10 : 1 based on the closest packing principle.<sup>22</sup>

A laboratory-based equipment was built for the experiment comprising a 3D printer and a syringe with a nozzle (0.4 mm in diameter). The paste was prepared with a preparation device

that agitated and heated the mixed materials at 70–80  $^{\circ}\text{C}$ , following which the paste was printed as per the software. The printing process is summarized in Fig. 1.

After printing, the green parts were placed in a muffle furnace (SX2-5-12, China) under the condition of carbon powder-embedding to explore the debinding process. Using 10 mg printed paste, thermogravimetric analysis (TG-DSC, STA449F3, Germany) was performed under  $\text{N}_2$  atmosphere ( $30\text{ mL min}^{-1}$ ) with experimental range 20–1050  $^{\circ}\text{C}$  and heating rate  $10\text{ }^{\circ}\text{C min}^{-1}$ . The microstructures of the samples were observed using a field emission scanning electron microscope (FE-SEM, SU8010, Hitachi, Japan) equipped with energy spectrometer. Before energy spectrum analysis, the sample was corroded using a mixture of  $\text{FeCl}_3 \cdot 6\text{H}_2\text{O}$  (analytical grade, 5 g), nitric acid ( $5\text{ mol L}^{-1}$ , 50 mL) and deionized water (100 mL), following which the sample was washed several times with deionized water. In addition to the debinding ratio, the shrinkage and burnout ratio of the samples were also investigated. Herein, debinding ratio refers to the ratio of binder removed relative to the total binder, while burnout ratio refers to the ratio of binder removed to the total copper paste.

## 3 Results and discussion

### 3.1 Debinding mechanism and mass transfer pathways

The TG curve (Fig. 2a) shows that the debinding process progressed through three main stages. The sample exhibited slight weight loss at 200  $^{\circ}\text{C}$ , indicating that the wax present on the paste surface started to melt and that the removal of wax was initiated. From 200 to 300  $^{\circ}\text{C}$ , the sample demonstrated severe weight loss, implying that the main stage of paraffin decomposition and removal occurred during this heating phase. As the temperature increased from 300 to 400  $^{\circ}\text{C}$ , the sample exhibited slight weight loss, indicating the end of paraffin decomposition. Beyond 400  $^{\circ}\text{C}$ , the sample quality was almost unchanged. In thermogravimetric experiments, the endothermic/exothermic value of the material system can be characterized through differential scanning calorimetry (DSC), the principle of which is to measure the relationship between the power (heat flow rate) difference between the sample and a reference *versus* temperature.

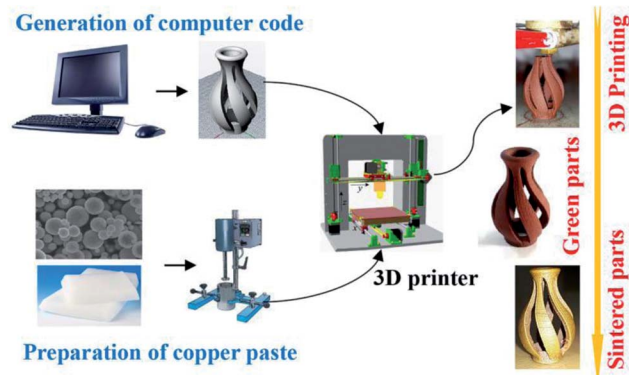


Fig. 1 The experimental method and printing process.

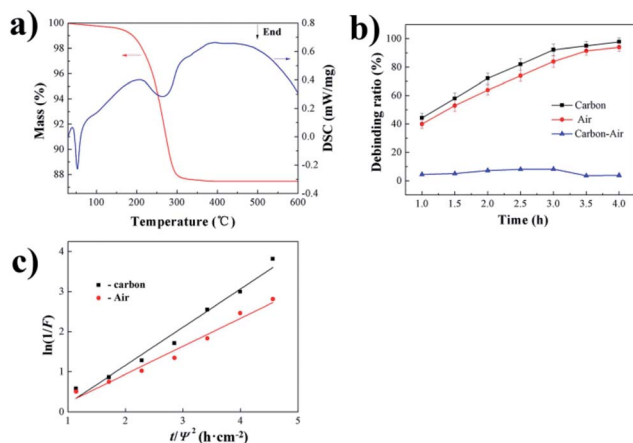


Fig. 2 Debinding mechanism and dynamics analysis: (a) TG–DTA curve of the sample; (b) debinding ratio curve of the sample; (c) fitting curve between  $\ln(1/F)$  and  $t/\Psi^2$ .

By characterizing the debinding ratio, we mainly analyzed the mass transfer pathways during debinding at 300 °C due to the most complicated mass transfer mechanism at this time. It can be found that when the temperature was 300 °C, the adhesive in the sample decomposed into a gas. Therefore, gas-phase mass transfer pathways were generally the process by which the gas-phase product discharged the sample from the inside to the outside, and the specific pathways included: (1) diffusion of paraffin-decomposed gas phase product in liquid paraffin; (2) diffusion of the paraffin-decomposed gas-phase product through previously formed pores; (3) spread of vaporized product of paraffin in liquid paraffin. Due to the embedded carbon powder, the mass transfer path also included liquid mass transfer, which was liquid phase migration under capillary forces.

The debinding ratio curve over time with embedded carbon powder and air environments are illustrated in Fig. 2b. The debinding ratio demonstrated a rising trend with time, but the debinding ratio with embedded carbon powder was slightly higher than that in air atmosphere; the difference contributed by the liquid phase migration under capillary forces could be neglected (Fig. 2b), indicating that the gas-phase mass transfer played a leading role in the debinding process.

### 3.2 Analysis of debinding diffusion mass transfer dynamics

**3.2.1 Diffusion coefficient calculation.** The above analysis shows that the diffusion of gas products was the main mass transfer channel. Hence, the diffusion coefficient could be used as a key indicator of this process and the mass transfer process could be described by the diffusion dynamics equation. In this study, the diffusion coefficient is designated  $d_i$ . According to the second law of Fick<sup>20</sup>, the relationship between the concentration of the gas phase product and time can be summarized as eqn (1).

$$\frac{\partial c}{\partial t} = d_i \left( \frac{\partial^2 C}{\partial x^2} \right) \quad (1)$$

where  $c$  is the gas-phase product concentration,  $t$  is the debinding time,  $d_i$  is the diffusion coefficient and  $x$  represents the coordinates of a point in the sample. By solving eqn (1), the fraction of remaining low molecular weight binder in the sample can be obtained, which can be expressed as eqn (2).

$$F = \frac{8}{\pi^2} \left[ \exp\left(\frac{-d_i t \pi^2}{4L^2}\right) + \frac{1}{9} \exp\left(\frac{-9d_i t \pi^2}{4L^2}\right) + \frac{1}{25} \exp\left(\frac{-25d_i t \pi^2}{4L^2}\right) + \dots \right] \quad (2)$$

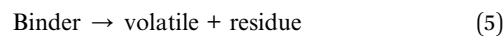
where  $F$  is the fraction of remaining low molecular weight binder,  $2L$  is the section thickness and  $t \gg 0$ . Some scholars have rewritten eqn (2) to suit different sizes of debinding<sup>23</sup>, which can be expressed as eqn (3) and (4).

$$\ln \frac{1}{F} = d_i \pi^2 \frac{t}{\Psi^2} + K_1 \quad (3)$$

$$\Psi = \frac{V}{S} \quad (4)$$

where  $S$  is the surface area,  $V$  is the volume,  $K_1$  is a constant term and  $\Psi$  represents the dimension of length. It is clear that  $\ln(1/F)$  and  $t/\Psi^2$  have a linear relationship and the slope depends on the diffusion coefficient. Hence, we fitted the plot of eqn (3) and the result of fitting is illustrated as Fig. 2c. The diffusion coefficient and Adj. R-Squa. obtained after linear fitting are shown in Table 1, implying excellent linear relationship. Analyzing Table 1, we found that the diffusion coefficient in the case of carbon powder embedding was higher than that in air atmosphere. This is probably because of the migration of the liquid phase under the capillary force in the environment of embedded carbon powder, resulting in rapid formation of interior pores in the sample, thus enhancing the efficiency of gas-phase mass transfer.

**3.2.2 Activation energy and pre-exponential factor.** Similar to the diffusion coefficient, the activation energy ( $E$ ) and pre-exponential factor ( $A$ ) are also important parameters in debinding dynamics. The Coats–Redfern method provides an effective theoretical basis for the calculation of activation energy ( $E$ ) and pre-exponential factor ( $A$ ). To calculate these two parameters, the main degreasing process was first simplified to the following equation:



Based on the kinetics of the non-isothermal thermogravimetric loss curve during debinding of MIM, the dynamics mechanism (eqn (5)) can be expressed as eqn (6):<sup>24,25</sup>

$$\ln \frac{G(\alpha)}{T^2} = \ln \frac{AR}{\beta E} - \frac{E}{RT} \quad (6)$$

Table 1 Diffusion coefficient

Deb. environment	Carbon	Air
$d_i/(\times 10^{-5} \text{ cm}^2 \text{ s}^{-1})$	2.68	1.96
Adj. R-Squa.	0.971	0.97

$RT/E \ll 1$ ,  $1 - 2RT/E \approx 1$ .  $G(\alpha) = -\ln(1 - \alpha)$ ,  $n = 1$ ;  $G(\alpha) = [1 - (1 - \alpha)^n]/(1 - n)$ ,  $n \neq 1$ ;  $n$ : reaction order;  $A$ : pre-exponential factor;  $R$ : gas constant,  $8.314 \text{ J mol}^{-1} \text{ K}^{-1}$ ;  $\beta$ : heating rate;  $E$ : activation energy;  $T$ : thermodynamic temperature;  $\alpha$ : conversion rate corresponding to time. The TG and DTG curves (the DTG curve represents the functional relationship between the rate of change of mass over time ( $dm/dt$ ) and time) for the copper paste in this study are shown in Fig. 3a. From eqn (6),  $\ln \frac{G(\alpha)}{T^2}$  and  $1/T$  show a linear relationship, so  $E$  and  $A$  can be calculated from the slope and intercept *via* fitting. In this study, it was assumed that the reaction order was 1 ( $n = 1$ ) and the fitting results are exhibited in Fig. 3b and Table 2. It can be found that Adj. R-Squa. was 0.9121, showing a good linear relationship, implying that it was reasonable to assume that the reaction order was 1.

### 3.3 The migration of solid phase materials and the diffusion of atoms

In the macroscopic process, the debinding process shows volume shrinkage and loss of quality. In addition to the gas-phase and the liquid-phase mass transfer at the microscopic level, the migration of copper powder and the diffusion of copper atoms in the initial stage of sintering are also included. Even in studies of MIM debinding, although limited data is available to explore the migration of solid particles, it is of critical importance to the dimensional accuracy of the metal components. In this study, the deficiencies in this aspect were corrected.

When the temperature was  $200 \text{ }^\circ\text{C}$ , the volume of the sample did not change and the burnout ratio was 3.95% (Fig. 4a and b), indicating that only gas phase or liquid phase mass transfer occurred at this stage and the positions of copper particles in the sample did not change. From  $200$  to  $300 \text{ }^\circ\text{C}$ , the burnout ratio and shrinkage increased significantly and the debinding rate reached 91.8% (Fig. 4a and b), revealing that the distance between the particles shortened, resulting in a macro volume change. The subsequent burnout ratio did not change significantly, while the shrinkage was almost unchanged, implying that this stage was the critical point for the transition from copper particle migration to copper atom diffusion. Simultaneously, it is exhibited that when the temperature was in the range  $500$ – $600 \text{ }^\circ\text{C}$ , the sample clearly shrank, implying that

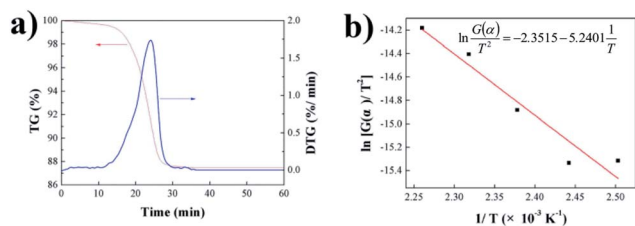


Fig. 3 Calculation of activation energy and pre-exponential factor: (a) the thermogravimetric and weight loss rate curves for the copper paste; (b) the fitting curve between  $\ln \frac{G(\alpha)}{T^2}$  and  $1/T$ .

Table 2 Activation energy and pre-exponential factor

Dynamics parameters	$E$ ( $\text{kJ mol}^{-1}$ )	$A$ ( $\text{min}^{-1}$ )	Adj. R-Square
Value	43.57	4989	0.9121

a sintered neck between the particles was gradually formed, at which time the initial diffusion of copper atoms occurred. Unfortunately, the above material migration process cannot be quantified using a simple model due to the lack of an effective theoretical basis. However, the mass transfer of the above-mentioned gas phase, liquid phase and solid phase materials can be described as shown in Fig. 4c.

### 3.4 Microstructure evolution during debinding process

The above mentioned results and the extrapolation could be confirmed from the microstructures of the samples at different temperatures (Fig. 5). It can be seen that the paraffin was gradually removed and the regular spherical copper particles became clearer with an increase in temperature. When it reached  $500 \text{ }^\circ\text{C}$ , powder with smaller diameter particles began to deform, slowly forming a sintered neck. On further increasing the temperature, all copper particles were sintered together and a large number of gaps could be observed in the structure. In the early stage of debinding, with the removal of paraffin, the initially dense microstructure of the sample became loose when the particles were simply physically bound. Subsequently, with the formation of the sintering neck the microstructure of the sample became dense again and the microstructure of the metal exhibited a metallurgical bonding mode.

### 3.5 The performance of sintered part

The above debinding process may not remove all the paraffin wax, but this can be completed by the sintering process, which is another important issue mentioned briefly in this study. On sintering at  $1000 \text{ }^\circ\text{C}$ , it is clear that the sample had smooth

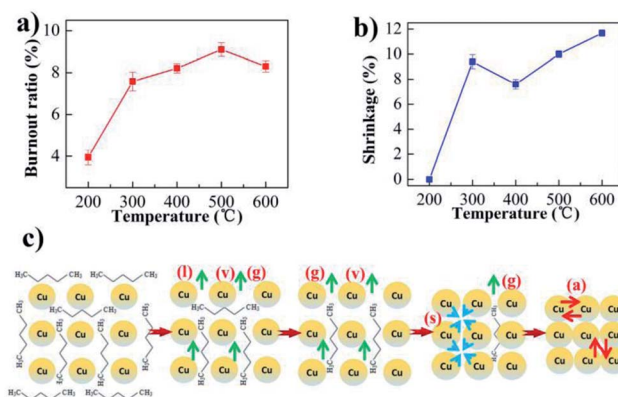


Fig. 4 Analysis of the migration of solid phase materials and mass transfer model: (a) burnout ratio curve of the sample; (b) shrinkage curve of the sample. (c) Mass transfer model.



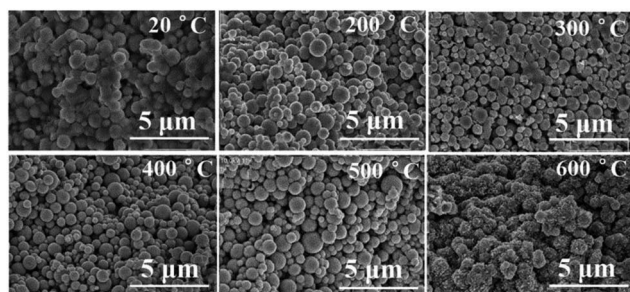


Fig. 5 SEM images of microstructures of samples at different debinding temperatures.

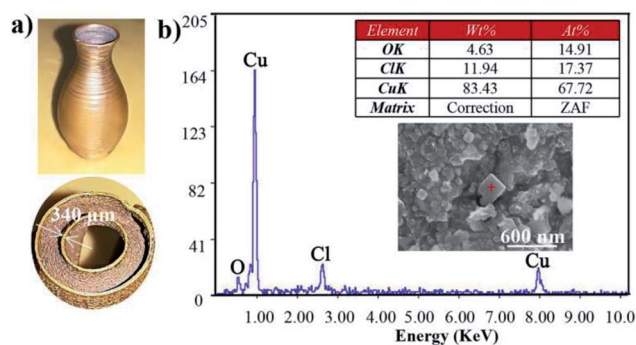


Fig. 6 The performance of sintered part: (a) sintered samples; (b) SEM images of sintered samples with energy spectral analysis.

surface flatness with superior metallurgical bonding. The thin wall of the sample was only 340  $\mu\text{m}$  thick (Fig. 6a). After testing, the hardness of the sintered parts was 80 HV and the density was 8.1  $\text{g cm}^{-3}$ . In addition, carbon was not found by the analysis of the SEM spectrum (Fig. 6b), indicating that the paraffin wax had been completely removed. Due to the use of ferric chloride solution in nitric acid (which was probably not cleaned later in the corrosion test), the experimental results also indicate the presence of Cl (Fig. 6b). In summary, metal paste injection 3D printing provides a new idea for the fabrication of complex 3D metal and alloy components by means of a low cost manufacturing method.

## 4 Conclusions

The mass transfer pathways of thermal debinding included liquid mass transfer under the capillary force and gas-phase mass transfer, but the dominant role was that of the gas-phase mass transfer. The diffusion mass transfer equation could effectively describe the debinding process in air atmosphere and when carbon powder was embedded. The diffusion coefficient quantitatively described the mass transfer processes such as thermal cracking, oxidative cracking and liquid phase volatilization. Material migration during the thermal debinding process was reflected in the macroscopic volume and microstructure evolution of the components. With removal of the adhesive, the sample changed from dense to loose and then to dense, during which time a transition from physical bonding to

metallurgical bonding took place. Combined with the sintering process, the sintered metal parts had smooth surface flatness and excellent metallurgical bonding; the thin wall of the part was only 340  $\mu\text{m}$  thick.

## Conflicts of interest

There are no conflicts to declare.

## Acknowledgements

We gratefully acknowledge the financial support by National Natural Science Foundation of China (Grant No. 51675496 and 51671091), Wuhan City Applied Basic Research Project, China (No. 2017010201010126). This paper is CJHI contribution CJHIWZ-2017006. The authors acknowledge the financial support of a Grant (CJHIXM-S201617) from Center for Jewelry Heritage and Innovation, a Hubei Provincial Key Research Base for Humanity and Social Sciences.

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